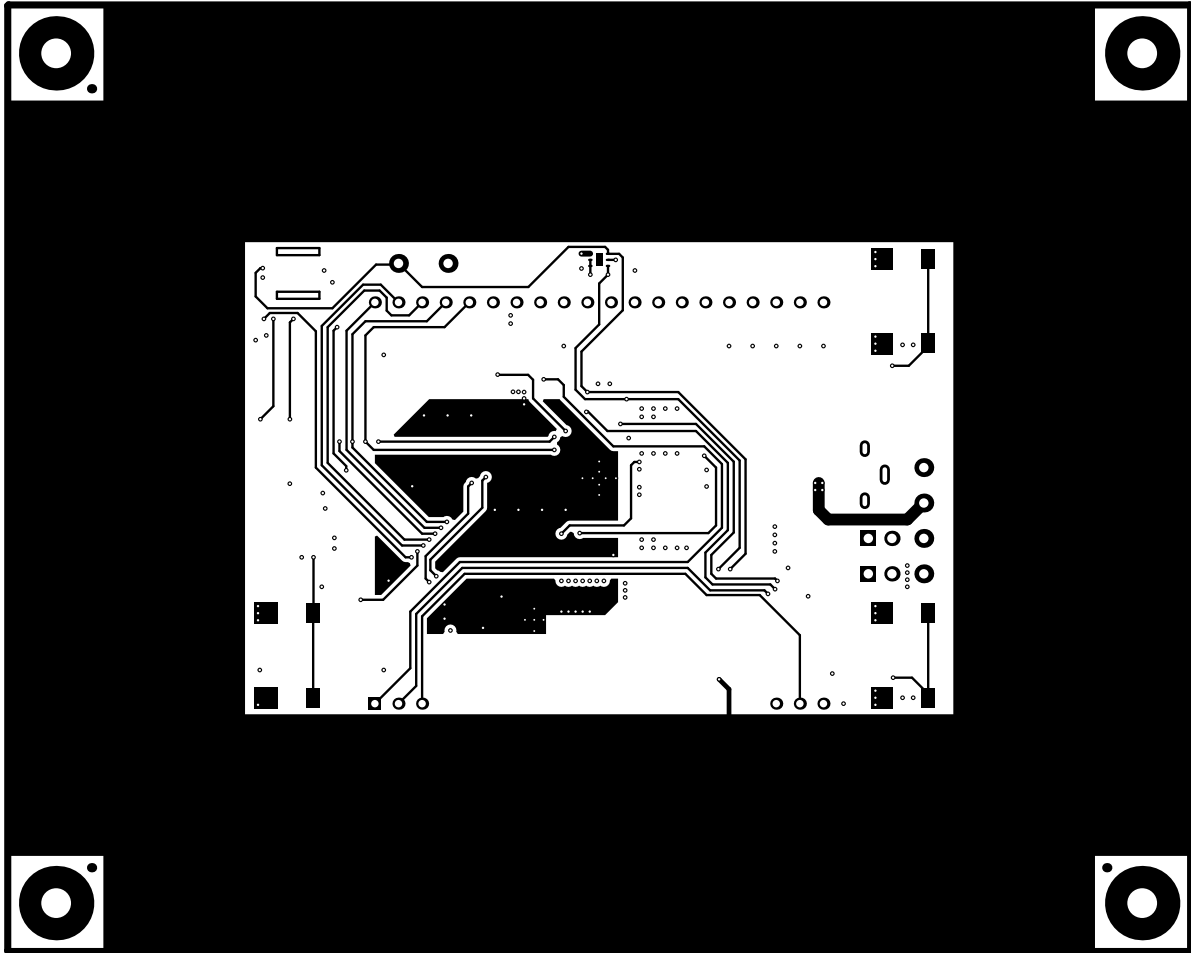
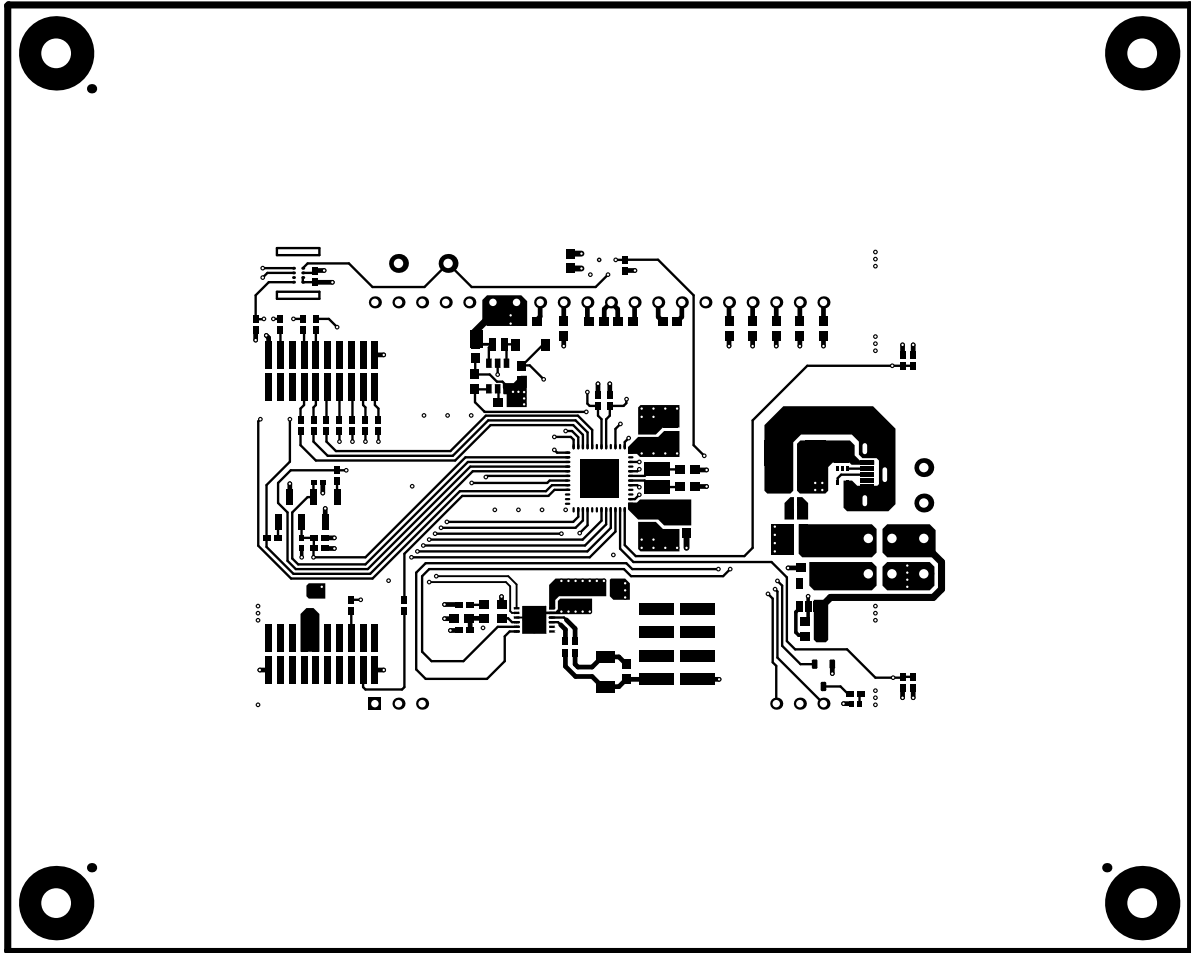


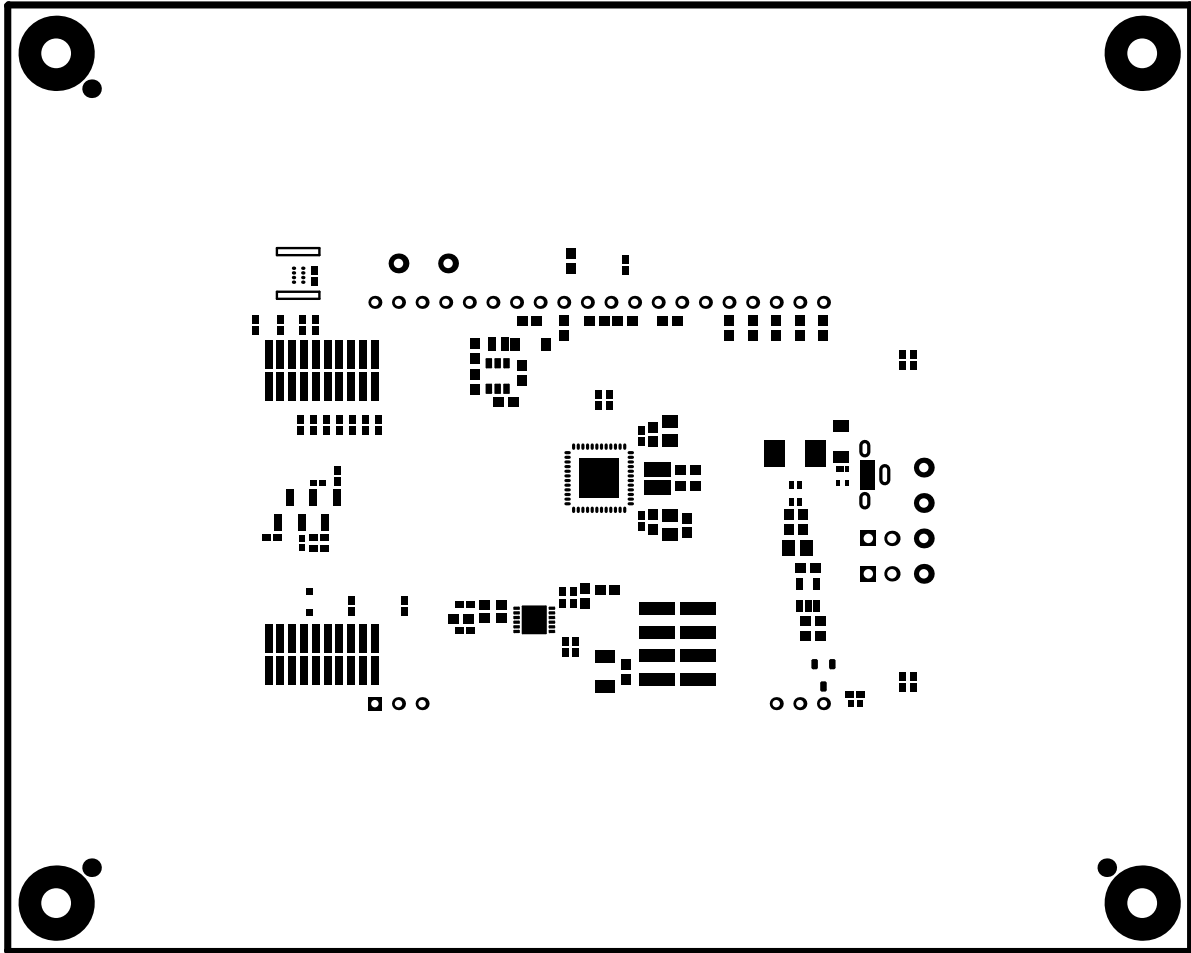
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01364	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 11/11/2016 11:15:47 AM	TEXAS INSTRUMENTS	



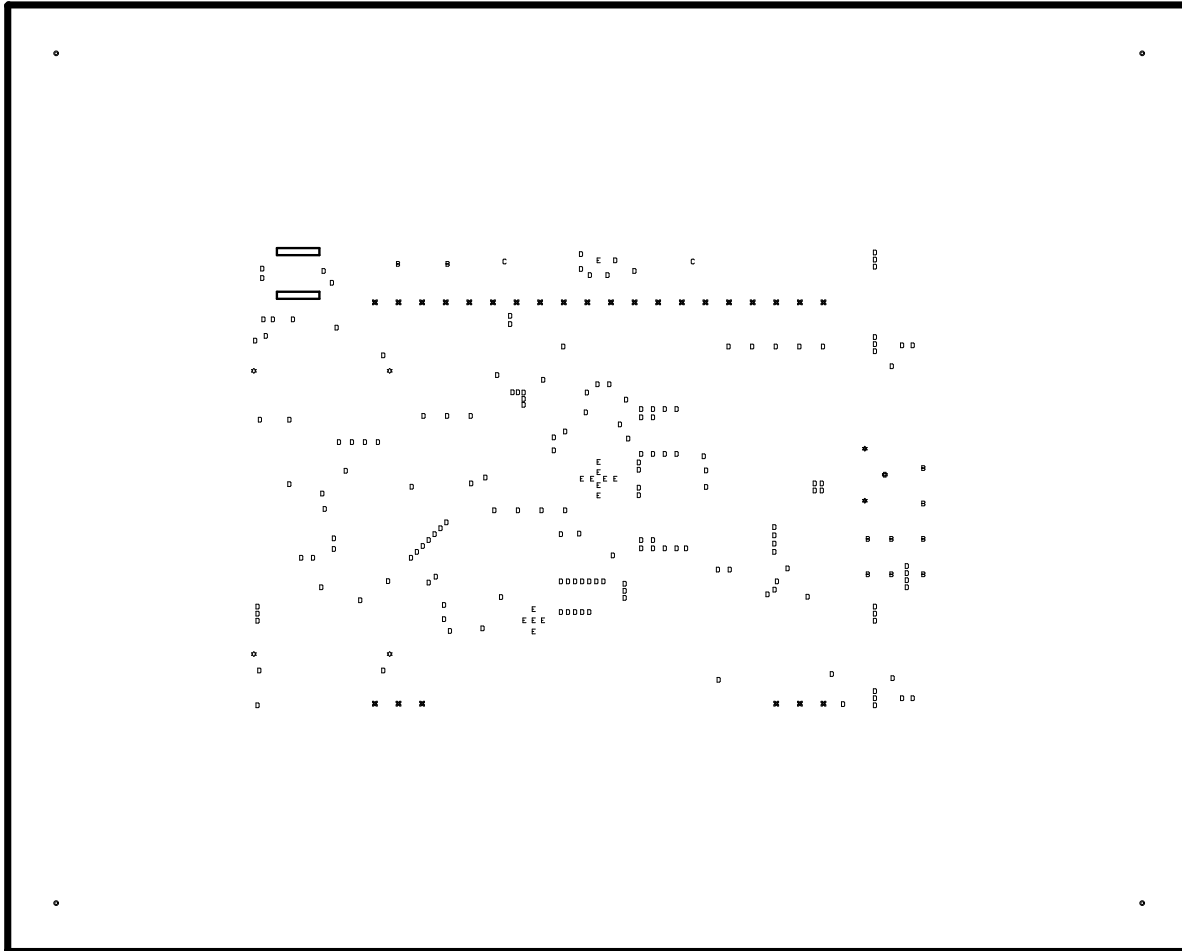
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01364	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 - Top Layer			
PLOT NAME = Top Layer	GENERATED : 11/11/2016 11:15:49 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01364	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Layer 4 - Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 11/11/2016 11:15:51 AM	TEXAS INSTRUMENTS	



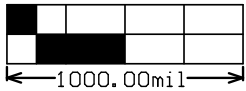
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01364	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 11/11/2016 11:15:52 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊛	4	57.09mil (1.450mm)	NPTH	Round
C	2	96.00mil (2.438mm)	NPTH	Round
E	14	7.87mil (0.200mm)	PTH	Round
D	171	10.00mil (0.254mm)	PTH	Round
⊗	26	31.50mil (0.800mm)	PTH	Round
B	10	40.00mil (1.016mm)	PTH	Round
⊙	4	125.98mil (3.200mm)	PTH	Round
⊛	2	19.69mil (0.500mm)	PTH	Slot
⊛	1	19.69mil (0.500mm)	PTH	Slot
234 Total				

Slot definitions : Routed Path Length = Calculated from tool start centre position to tool end centre position.
Hole Length = Routed Path Length + Tool Size = Slot length as defined in the PCB layout

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01364	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 11/11/2016 11:15:55 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01364	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 11/11/2016 11:15:56 AM	TEXAS INSTRUMENTS	

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